

# Intel® Firmware Support Package (Intel® FSP) for 6<sup>th</sup> Generation Intel® Core™ Processor Code-Named SkyLake (SKL) Gold

**Release Notes** 

**July 2016** 



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# **Revision History**

These are the main releases of Intel® Firmware Support Package (Intel® FSP) for  $6^{th}$  Generation Intel® Core<sup>TM</sup> Processor Code-Named SkyLake.

Date	Revision	Description
Jul 20, 2016	GOLD	Gold Release for IOTG supported H Sku
March 14, 2016	BETA	Beta Release for IOTG supported H Sku



## 2.0 Introduction

This package contains required binary image(s) and collateral for the Intel® Firmware Support Package (Intel® FSP) for 6<sup>th</sup> Generation Intel® Core™ Processor code-named SkyLake H Sku

Compliant with FSP 1.1 External Architecture Specification.

This document provides system requirements, installation instructions, issues and limitations, and legal information.

To learn more about this product, see:

- New and previously new features listed in <u>Section 3.0, New in This Release</u>.
- Reference documentation listed in <u>Section 2.2, Related Documentation, Tools, and Packages.</u>

The following table lists the relevant platform software components used during development and validation of this release.

#### **Table 1. Platform Software Component Information**

Component	Gold	
Microcode Update (R0-stepping)	m36506E3_00000092	
Microcode Update (Q0-stepping)	m22506E1_0000002A	

## 2.1 Terminology

The following terms are used in this document.

#### Table 2. Terminology

Term	Description
API	Application Programming Interface
BSF	Binary Settings File
ВСТ	Binary Configuration Tool
CRB	Customer Reference Board
Intel® EDC	Intel® Embedded Design Center
Intel® FSP	Intel® Firmware Support Package
SoC	System on Chip



#### 2.2 Related Documentation, Tools, and Packages

#### Table 3. Related Documentation, Tools, and Packages

Document	Location
Intel® Firmware Support Package (Intel® FSP) for the SkyLake Platform Integration Guide	Available in this release package
Intel® Binary Configuration Tool for Intel® Firmware Support Package	www.intel.com/fsp

#### 2.3 Intended Audience

The intended audience is platform and system developers who intend to use an Intel® FSP-based boot loader for the firmware solution for their overall design based on the Intel® Core™ Processor code-named SkyLake. This group includes, but is not limited to, system BIOS developers, boot loader developers, and system integrators.

#### 2.4 Customer Support

Intel offers support for this software at the API level only, defined in the Intel® FSP Integration Guide and reference manuals listed in <u>Section 2.2, Related Documentation</u>, <u>Tools</u>, and <u>Packages</u>.

For technical support, please raise IPS (Intel® Premier Support) at https://shnintelsf2crm.intel.myshn.net/home/home.jsp

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## 3.0 New in This Release

#### 3.1 New Features

- Add support for DDR4 DDP parts with shared clock and ZQ pins
- MRC shall ensure DDR4 Self Refresh is set to ASR Mode

#### 3.2 Beta Features

- FSP BCT configuration support (via BCT 3.2.1)
- Boot Guard verified boot support

#### 3.3 Alpha Features

- SkyLake Processor Q0 stepping and Sunrise Point PCH Do stepping
- DDR4 Memory Detection and Initialization
- MTRR Initialization on all CPU threads
- PCI Express, SATA, XHCI initialization
- Configuration options through Intel BCT tool
- Rebase to a different base address through Intel BCT tool



## 4.0 Fixed Issues

The following table contains the fixed issues in this release:

- Request policy to active the patch fix using BIOS Mailbox to cater MPS VR bug with decay
- MEI driver got yellow bang and not disappear in Device manager when press hot key to pull up HDA\_SDO
- During POST if system BIOS pass NULL of UPD region pointer to FSPinitApi of FSP then system will hang
- MrcSetupVtt uses hard-coded value for CMD Target



# 5.0 Limitations

- 5.1 Current Release
  - None
- 5.2 Previous Releases
  - None



# 6.0 Known Issues

## 6.1 Current Release

None



# 7.0 Where to Find the Release

This package can be found at CDI



## 8.0 Release Content

This release contains:

- Intel® FSP Integration Guide
- Intel® FSP Binary
- Binary Settings File (BSF)
- Release Notes



# 9.0 Hardware and Software Compatibility

### 9.1 Supported Hardware

This Intel® Firmware Support Package (Intel® FSP) release is specifically targeted for 6<sup>th</sup> Generation Intel® Core™ Processor code-named SkyLake, SKL H Xeon® E3-1505L and E3-1515M.

## 9.2 Supported Operating Systems

This release can be installed on either a Windows\* or a Linux\* system. However, the Intel® FSP binary itself can be used with any software development environment to generate a complete boot loader solution.

The software in this release has been validated on customer reference boards (CRBs) with the boot loader and operating systems listed in the following table.

#### Table 4. Operating System/Boot Loader Support

Product Family	Boot Loader	Operating System	
6 <sup>th</sup> Generation Intel® Core™ Processor code-named SkyLake	Coreboot* with the UEFI payload	Yocto Project* Windows 10 Core	
6 <sup>th</sup> Generation Intel® Core™ Processor code-named SkyLake	SeaBios legacy payload	Windows 7	
6 <sup>th</sup> Generation Intel® Core™ Processor code-named SkyLake	U-Boot payload	Yocto Project*	



# 10.0 Configuration

Intel® Binary Configuration Tool (BCT) for Intel® Firmware Support Package (Intel® FSP) is provided as a companion tool and is intended to be used to:

- Customize the Intel® FSP binary configuration options based on the Binary Settings File (BSF).
- Rebase the Intel® FSP binary to a different base address.

It is recommended to use the latest version of Intel® Binary Configuration Tool with this release.

See *Intel® Binary Configuration Tool User Guide* for the usage instructions. See <u>Section 2.2, Related Documentation, Tools, and Packages</u>, for information on where to download the tool.

### 10.1 Rebasing

When integrating Intel® FSP with a boot loader, place Intel® FSP at the same base address that it is configured to. Intel® Binary Configuration Tool can be used to rebase the Intel® FSP binary.

#### 10.2 Microcode

Use the latest microcode when integrating Intel® FSP. Any processor that does not have the correct microcode update loaded is considered to be operating out of specification. See the integration guide for more details regarding microcode loading.